## DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63) COMBINED WITH POWER OF ATTORNEY

| Declaration Submitted with   | Declaration Submitted after   | Attorney Docket Nu                                 | mber                                 | SC1186/MP                           |
|--|---|--|--------------------------------------|-------------------------------------|
| Initial Filing   | Initial Filing (surcharge<br>(37 CFR 1.16(e)) required)   | First Named Invento                                | or                                   | Wai Yew LO                          |
|  |   | Application Number                                 | ·                                    |                                     |
|  |   | Filing Date  |                                      |                                     |
| Regular (Utility) Application  | Design application  | Group Art Unit                                     |                                      |                                     |
|  |   | Examiner Name                                      |                                      |                                     |
| As a below named inventor, I h   | ereby declare that:   |  |                                      |                                     |
| My residence, post office address  | s, and citizenship are as stated belo   | w next to my name.                                 |                                      |                                     |
| I believe I am the original, first a listed below) of the subject matter | nd sole inventor (if only one name<br>r which is claimed and for which a p  | is listed below) or an o atent is sought on the in | riginal, first and vention entitled: | joint inventor (if plural names are |
|  | STACKED DIE SEM   | IICONDUCTOR DEVICE                                 |                                      |                                     |
| the specification of which:  |   |  |                                      |                                     |
| is attached hereto   | was filed or  | n:   | <del>-</del>                         |                                     |
|  | as U.S. Ser   | ial No.:   |                                      |                                     |
|  | and was an  | nended on:   | (if applicable                       | ·)                                  |
| I hereby state that I have reviewed amendment referred to above.         | ed and understand the contents of t   | he above-identified spec                           | cification, includi                  | ng the claims, as amended by any    |
| I acknowledge the duty to discle<br>Federal Regulations, Section 1.5     | ose information which is material to 6(a).  | the patentability of this                          | s application in a                   | accordance with Title 37, Code of   |
| patent or inventor's certificate(s)                                      | nefits under Title 35, United States, or 365(a) of any PCT internationa w and have also identified below tional application having a filing dat | l application which design by checking the box     | gnated at least o                    | application for patent, inventor's  |
| Prior Foreign Application<br>Number(s)                                   | Country   | Foreign Filing Date (MM/DD/YYYY)                   | Priority Not<br>Claimed              | Certified Copy Attached?            |
|  |   |  |                                      | ☐ Yes ☐ No                          |
|  |   |  |                                      | Yes No                              |
|  |   |  | DTO /05/225                          |                                     |
| Additional foreign application   | on numbers are listed on a supplement   | ental priority data sheet                          | PTO/SB/02B atta                      | acned nereto:                       |

I hereby claim the benefit under Title 35, United States Code § 119(e) of any United States provisional application(s) listed below:

| Provisional Application Serial No.:  |  |
|--------------------------------------|--|
| Provisional Application Filing Date: |  |

I hereby claim the priority benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which is material to the patentability of this application and which occurred between the filling date of the prior application and the national or PCT international filling date of this application:

Prior U.S. Application(s):

no such application(s) filed

such application(s) identified as follows:

| Application No. | Filling Date<br>(day, month, year) | Status<br>(Patented, Pending, Abandoned) |
|-----------------|------------------------------------|--|
|                 |                                    |  |
|                 |                                    |  |

I hereby declare that: as to any claimed subject matter of this application which is common to my earlier United States or foreign application(s), if any, which I have identified above and claimed the benefit of priority thereof, I do not believe that the same was ever known or used in the United States before my invention thereof or patented or described in any printed publication in any country before my invention thereof or more than one year prior to the first of said earlier application(s), or in public use or on sale in the United States more than one year prior to the first of said earlier application(s), and that the said common subject matter has not been patented or made the subject of an inventor's certificate before the date of the first of said earlier U.S. application(s) in any country foreign to the United States on an application, filed by me or my legal representatives or assigns more than twelve months (six months if the present application is a Design patent application) prior to the first of said earlier U.S. application(s), if any; and that, as to any claimed subject matter of this application which is not common to said earlier application(s), if any, I do not know and do not believe that the same was ever known or used in the United States before my invention thereof or patented or described in any printed publication in any country before my invention thereof or more than one year prior to the date of this application, or in public use or on sale in the United States more than one year prior to the date of this application, and that said subject matter has not been patented or made the subject of an inventor's certificate in any country foreign to the United States on an application filed by me or my legal representatives or assigns more than twelve months (six months if the present application is a Design patent application) prior to the date of this application.

I hereby appoint the attorney(s) or agent(s) associated with: Customer Number to prosecute this application and transact all business in the

patent and trademark office connected therewith.

Address all telephone calls to:

Telephone:

Facsimile:

602-952-4376

Address all correspondence to: Customer Number 23330

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

| Full name of first-named or                               | sole inventor              | WAI YEW LO                |                          |  |
|---|----------------------------|---------------------------|--------------------------|--|
| Inventor's signature                                      | Lines                      |                           | Date 12 10 01            |  |
| <b>.</b>  | 00 I I B II I 0 I 0 B . I' |                           |                          |  |
|   | 30 Jalan PJU 3/23 Petaling | Jaya                      | Selangor                 |  |
|   | City                       |                           | State or Foreign Country |  |
| Citizenship Malays  |                            |                           | _                        |  |
|   | Country                    |                           |                          |  |
| Post Office Address                                       | No. 30 Jalan PJU 3/23      |                           |                          |  |
|   |                            | Street Address            |                          |  |
| D . "   | •                          |                           | 47040                    |  |
| Petaling Jaya   |                            | elangor<br>ate or Country | 47810<br>Zip Code        |  |
| City  |                            | ate of Country            | Zip Code                 |  |
|   |                            |                           |                          |  |
| Full name of second-named joint inventor AZHAR BIN ARIPIN |                            |                           |                          |  |
| Inventor's signature                                      | 21.0                       |                           | Date 12/10/01.           |  |
| Residence   |                            |                           | Selangor                 |  |
|   | City                       |                           | State or Foreign Country |  |
| Oldina a shina a Mala sa                                  |                            |                           |                          |  |
| Citizenship Malays  | Country                    |                           | <del>_</del>             |  |
|   | Country                    |                           |                          |  |
| Post Office Address                                       | Lot 16403 Bt 5 Kg Johan    | Setia Kelang              |                          |  |
|   |                            | Street Address            |                          |  |
|   | 5                          | Selangor                  | 41200                    |  |
| City  |                            | ate or Country            | Zip Code                 |  |

| Full name of third-named joint inventor  Inventor's signature | KONG BEE TIU                 | Date                     |
|---|------------------------------|--------------------------|
| Residence Port Klang  |                              | Selangor                 |
| City  |                              | State or Foreign Country |
| Citizenship Malaysia Co                                       | untry                        |                          |
| Post Office Address 69, Jln Ja                                | gong, Pandamaran             |                          |
|   | Street Address               |                          |
| Port Klang<br>City  | Selangor<br>State or Country | 42000<br>Zip Code        |